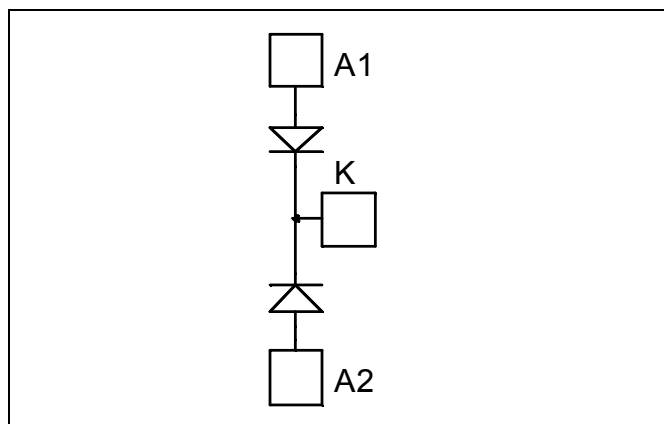


Dual Common Cathode diodes Power Module

$V_{RRM} = 1700V$
 $I_C = 400A @ T_c = 55^\circ C$



Application

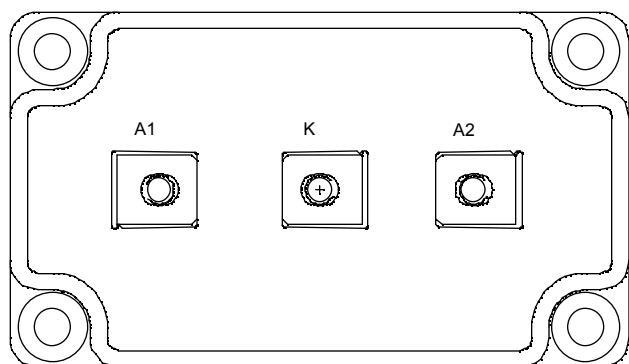
- Uninterruptible Power Supply (UPS)
- Induction heating
- Welding equipment
- High speed rectifiers

Features

- Ultra fast recovery times
- Soft recovery characteristics
- High blocking voltage
- High current
- Low leakage current
- Very low stray inductance
 - Symmetrical design
 - M5 power connectors
- High level of integration

Benefits

- Outstanding performance at high frequency operation
- Low losses
- Low noise switching
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- RoHS Compliant



Absolute maximum ratings

Symbol	Parameter			Max ratings	Unit	
V _R	Maximum DC reverse Voltage			1700	V	
V _{RRM}	Maximum Peak Repetitive Reverse Voltage					
I _{F(AV)}	Maximum Average Forward Current	Duty cycle = 50%	T _c = 25°C	480	A	
			T _c = 55°C	400		
I _{F(RMS)}	RMS Forward Current			500		
I _{FSM}	Non-Repetitive Forward Surge Current		T _j = 25°C	1500		

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

All ratings @ $T_j = 25^\circ\text{C}$ unless otherwise specified

Electrical Characteristics

<i>Symbol</i>	<i>Characteristic</i>	<i>Test Conditions</i>		<i>Min</i>	<i>Typ</i>	<i>Max</i>	<i>Unit</i>
V _F	Diode Forward Voltage	I _F = 400 A	T _J = 25°C		2.2	2.5	V
			T _J = 125°C		2.1		
I _{RM}	Maximum Reverse Leakage Current	V _R = 1700 V	T _J = 25°C			750	μA
			T _J = 125°C			1000	

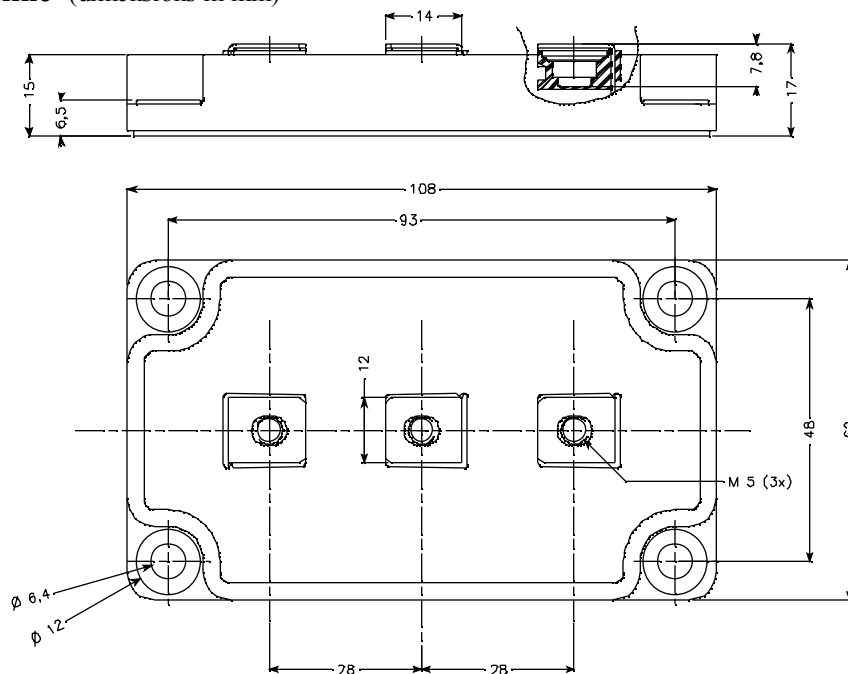
Dynamic Characteristics

<i>Symbol</i>	<i>Characteristic</i>	<i>Test Conditions</i>	<i>Min</i>	<i>Typ</i>	<i>Max</i>	<i>Unit</i>
t_{rr}	Reverse Recovery Time	$I_F = 400\text{ A}$ $V_R = 900\text{ V}$ $di/dt = 4000\text{ A}/\mu\text{s}$	$T_j = 25^\circ\text{C}$		572	ns
			$T_j = 125^\circ\text{C}$		704	
Q_{rr}	Reverse Recovery Charge		$T_j = 25^\circ\text{C}$		80	μC
			$T_j = 125^\circ\text{C}$		140	
I_{RRM}	Reverse Recovery Current		$T_j = 25^\circ\text{C}$		280	A
			$T_j = 125^\circ\text{C}$		400	

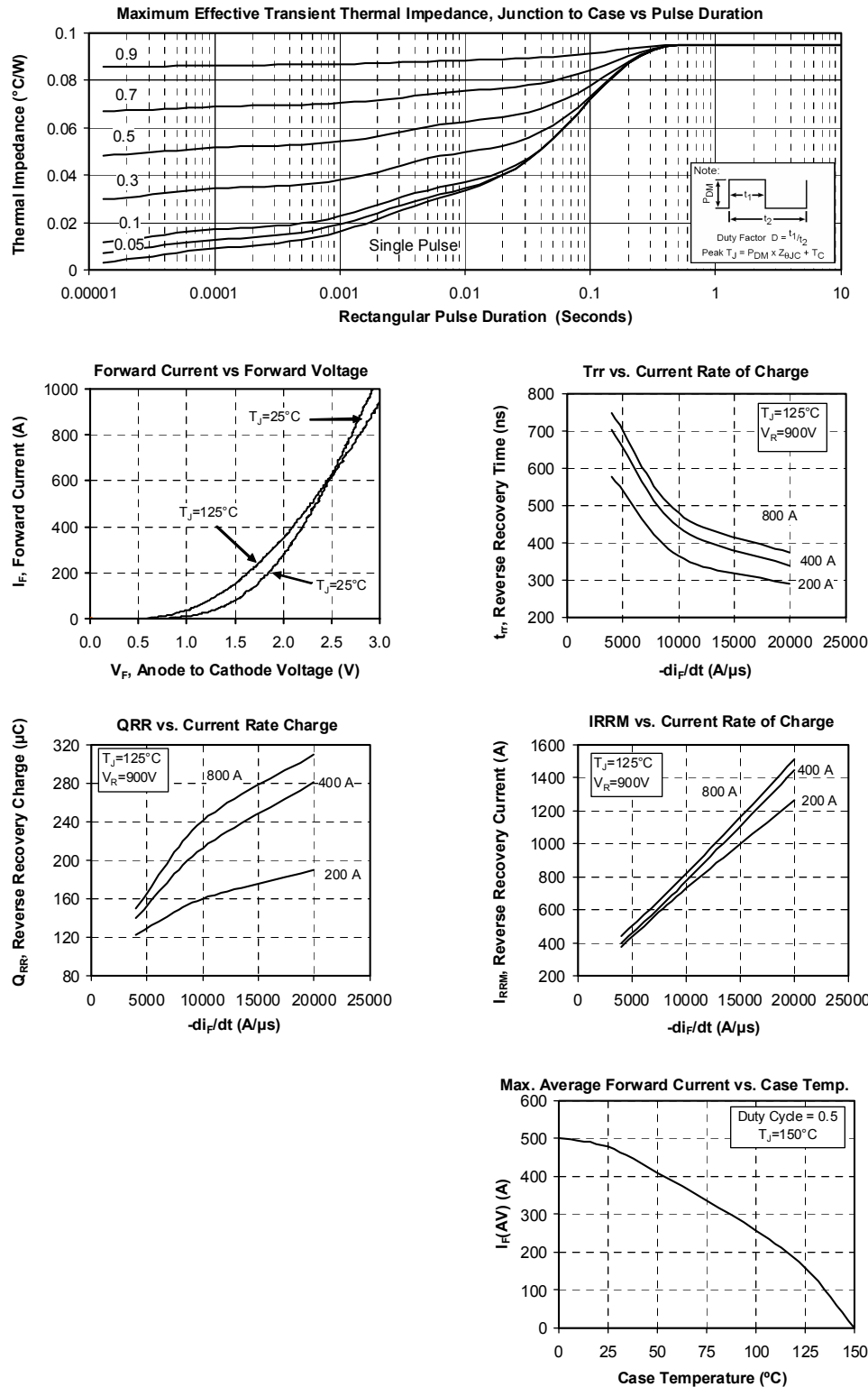
Thermal and package characteristics

Symbol	Characteristic			Min	Typ	Max	Unit
R _{thJC}	Junction to Case Thermal Resistance					0.095	°C/W
V _{ISOL}	RMS Isolation Voltage, any terminal to case t =1 min, I isol<1mA, 50/60Hz			3500			V
T _J	Operating junction temperature range			-40		150	°C
T _{STG}	Storage Temperature Range			-40		125	
T _C	Operating Case Temperature			-40		100	
Torque	Mounting torque	To heatsink	M6	3		5	N.m
		For terminals	M5	2		3.5	
Wt	Package Weight					280	g

SP6 Package outline (dimensions in mm)



Typical Performance Curve



Microsemi reserves the right to change, without notice, the specifications and information contained herein

Microsemi's products are covered by one or more of U.S. patents 4,895,810 5,045,903 5,089,434 5,182,234 5,019,522 5,262,336 6,503,786 5,256,583 4,748,103 5,283,202 5,231,474 5,434,095 5,528,058 and foreign patents. U.S. and Foreign patents pending. All Rights Reserved.